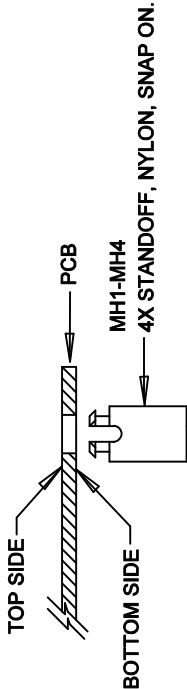


**NOTES: UNLESS OTHERWISE SPECIFIED**

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 C.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
5. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
6. INSTALL 4 STANDOFFS AT 4 LOCATIONS AS SHOWN BELOW:



APPROVALS		1630 MCCARTHY BLVD MILPITAS, CA 95035 PHE (408)432-1900 www.linear.com LTC CONFIDENTIAL FOR CUSTOMER USE ONLY	
PCB DES.		TITLE: TOP ASSEMBLY DRAWING	
APP ENG.		40V STEP-DOWN REGULATOR WITH DUAL LDOS	
		SIZE	REV.
		N/A	4
		IC NO. LT3667EUDD	DEMO CIRCUIT 1869A
SCALE = NONE		FILENAME: 1869A-Rev4.PCB	SHT 1 OF 2